

N and P Channel Enhancement Mode Power MOSFET

Description

This Product uses advanced trench technology MOSFETs to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

● **NMOS**

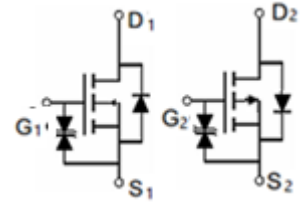
- V_{DS} 20V
- I_D (at $V_{GS} = 10V$) 1.36A
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 375m Ω
- $R_{DS(ON)}$ (at $V_{GS} = 2.5V$) < 450m Ω
- $R_{DS(ON)}$ (at $V_{GS} = 1.8V$) < 800m Ω

● **PMOS**

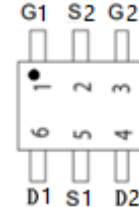
- V_{DS} -20V
- I_D (at $V_{GS} = -10V$) -1.15A
- $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 520m Ω
- $R_{DS(ON)}$ (at $V_{GS} = -2.5V$) < 700m Ω
- $R_{DS(ON)}$ (at $V_{GS} = -1.8V$) < 1000m Ω
- 100% Avalanche Tested
- RoHS Compliant
- ESD (HBM)>2.0KV

Application

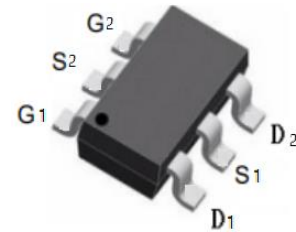
- Power switch
- DC/DC converters



Schematic diagram



Marking and pin assignment



SOT-23-6L

Device	Package	Marking	Packaging
G1NP02ELL	SOT-23-6	G1NP02	3000pcs/Reel

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted

Parameter	Symbol	NMOS	PMOS	Unit
Drain-Source Voltage	V_{DS}	20	-20	V
Continuous Drain Current	I_D	1.36	-1.15	A
Pulsed Drain Current (note1)	I_{DM}	5.4	-3.4	A
Gate-Source Voltage	V_{GS}	± 10	± 10	V
Power Dissipation	P_D	1.12	1.12	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	-55 To 150	$^{\circ}C$

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	111	$^{\circ}C/W$

NMOS Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 10V$	--	--	± 10	μA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.35	0.55	1	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 0.65A$	--	159	370	m Ω
		$V_{GS} = 2.5V, I_D = 0.55A$	--	209	450	
		$V_{GS} = 1.8V, I_D = 0.45A$	--	290	800	
Forward Transconductance	g_{FS}	$V_{DS}=10V, I_D=0.5A$	--	1.6	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = 10V,$ $f = 1.0MHz$	--	60	--	pF
Output Capacitance	C_{oss}		--	15	--	
Reverse Transfer Capacitance	C_{rss}		--	5	--	
Total Gate Charge	Q_g	$V_{DD} = 10V,$ $I_D = 250mA,$ $V_{GS} = 4.5V$	--	750	--	pC
Gate-Source Charge	Q_{gs}		--	75	--	
Gate-Drain Charge	Q_{gd}		--	225	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 10V,$ $I_D = 0.5A,$ $R_G = 10\Omega$	--	6.7	--	ns
Turn-on Rise Time	t_r		--	4.8	--	
Turn-off Delay Time	$t_{d(off)}$		--	17.3	--	
Turn-off Fall Time	t_f		--	7.4	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	1.36	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = 0.5A, V_{GS} = 0V$	--	--	1.2	V

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

NMOS Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

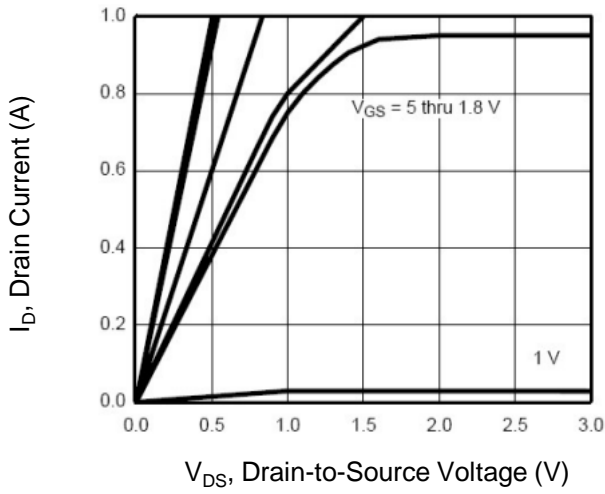


Figure 2. Transfer Characteristics

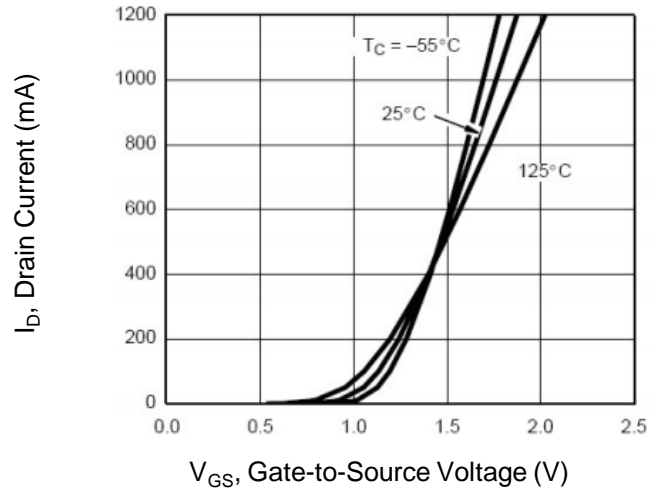


Figure 3. Drain-Source On-Resistance

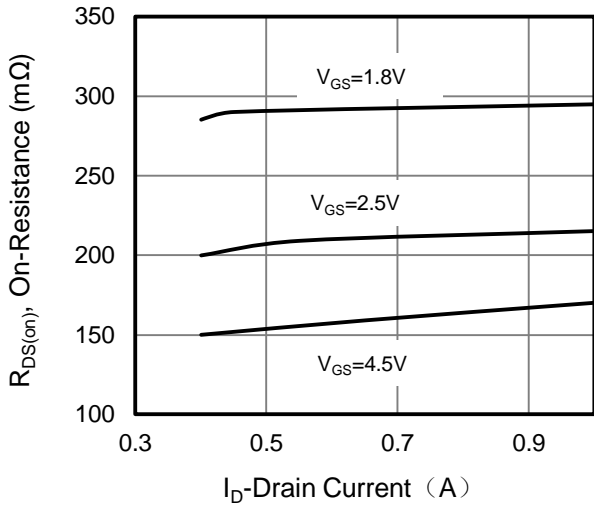


Figure 4. Gate Charge

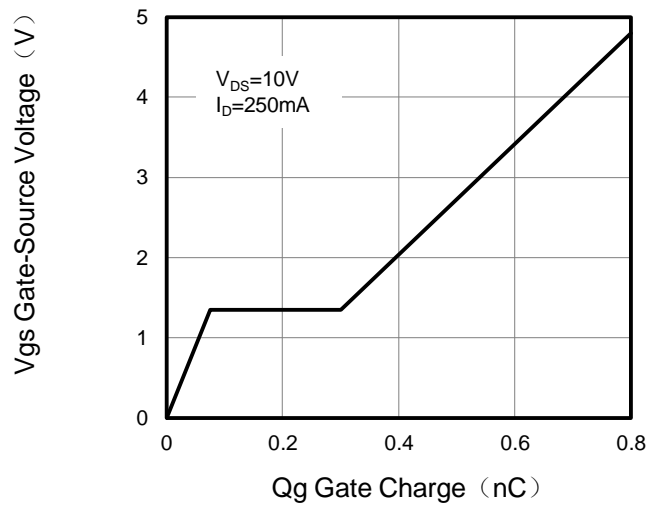


Figure 5. Capacitance

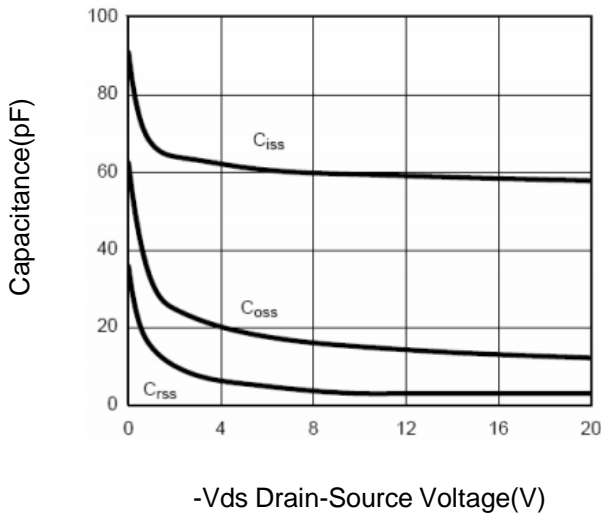
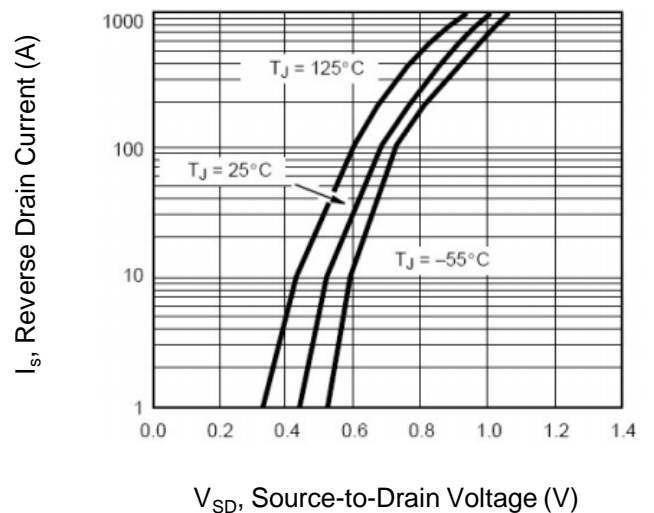


Figure 6. Source-Drain Diode Forward



NMOS Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

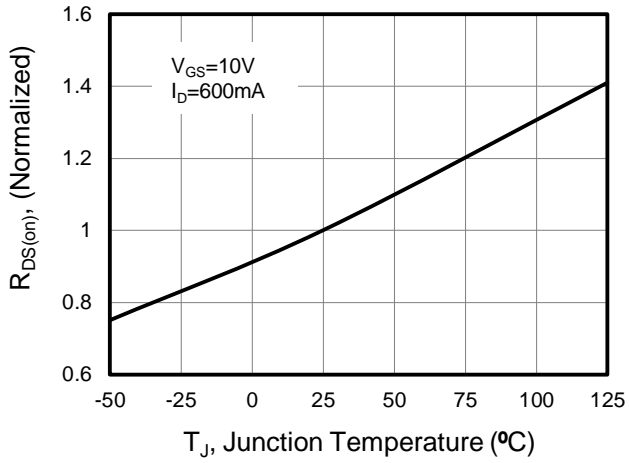


Figure 8. Safe Operation Area

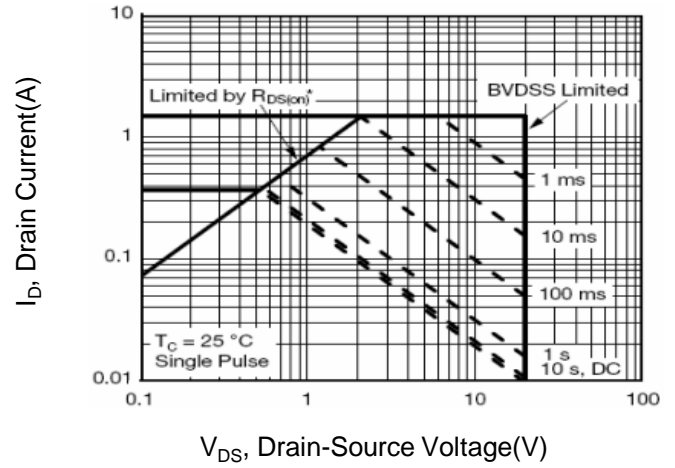
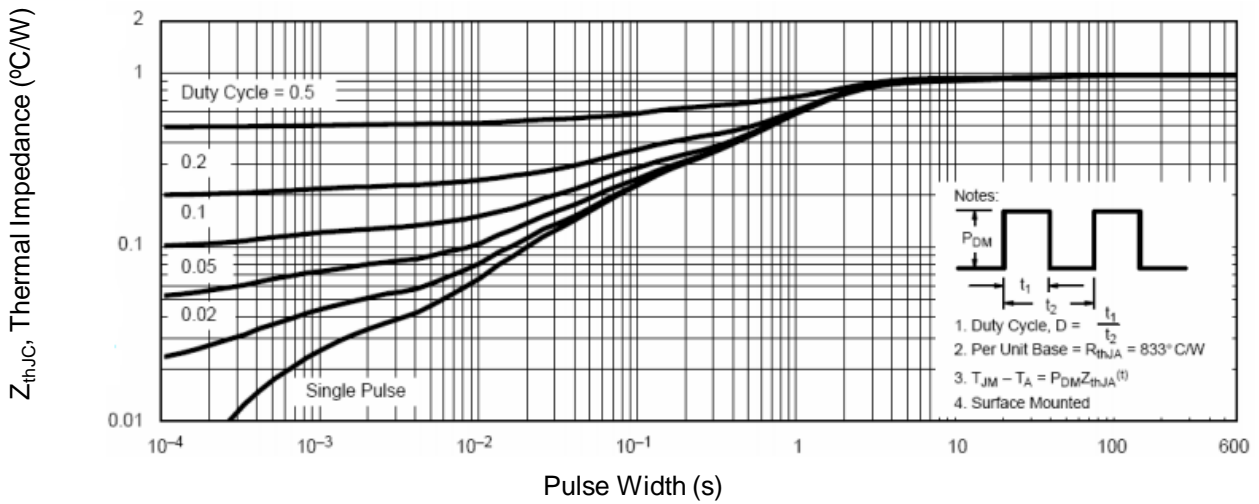


Figure 9. Normalized Maximum Transient Thermal Impedance



PMOS Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -20V, V_{GS} = 0V$	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 10V$	--	--	± 10	μA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.35	-0.55	-0.8	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -0.5A$	--	375	520	m Ω
		$V_{GS} = -2.5V, I_D = -0.5A$	--	478	700	
		$V_{GS} = -1.8V, I_D = -0.5A$	--	621	1000	
Forward Transconductance	g_{FS}	$V_{DS} = -5V, I_D = -0.6A$	--	1.7	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{GS} = 0V,$ $V_{DS} = -10V,$ $f = 1.0MHz$	--	68.4	--	pF
Output Capacitance	C_{oss}		--	17	--	
Reverse Transfer Capacitance	C_{rss}		--	5.7	--	
Total Gate Charge	Q_g	$V_{DD} = -10V,$ $I_D = -250mA,$ $V_{GS} = -4.5V$	--	855	--	pC
Gate-Source Charge	Q_{gs}		--	85.5	--	
Gate-Drain Charge	Q_{gd}		--	256.5	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -10V,$ $I_D = -0.6A,$ $R_G = 3\Omega$	--	6.5	--	ns
Turn-on Rise Time	t_r		--	6.5	--	
Turn-off Delay Time	$t_{d(off)}$		--	18.2	--	
Turn-off Fall Time	t_f		--	5.5	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	-1.15	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = -0.5A, V_{GS} = 0V$	--	--	-1	V

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

PMOS Typical Characteristics $T_j = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

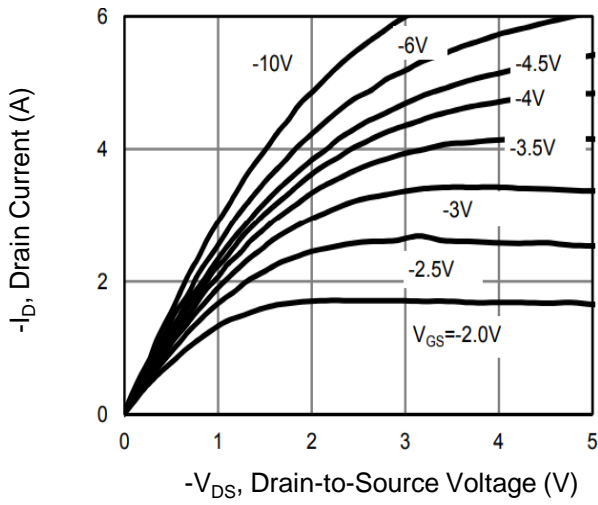


Figure 2. Transfer Characteristics

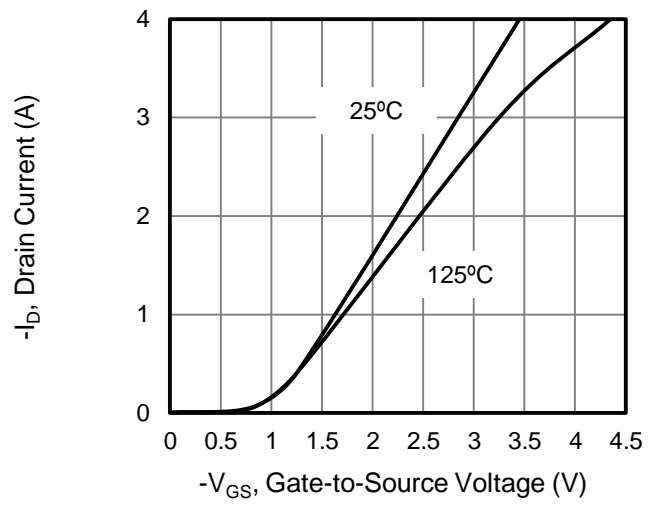


Figure 3. $R_{DS(on)}$ -Drain Current

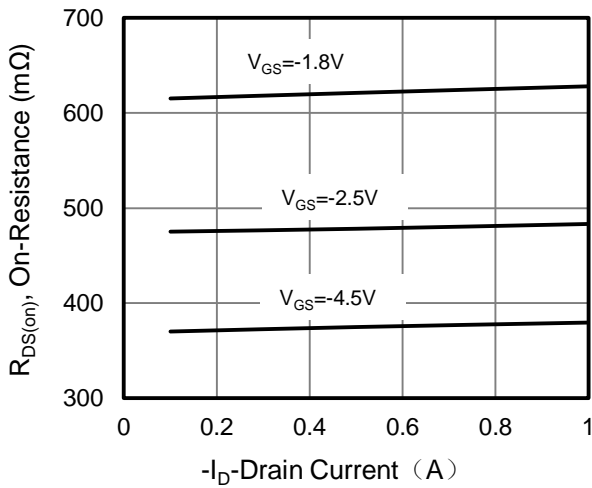


Figure 4. Gate Charge

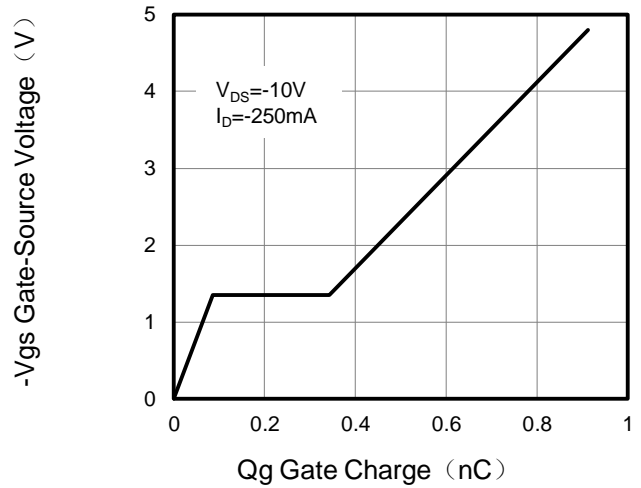


Figure 5. Capacitance

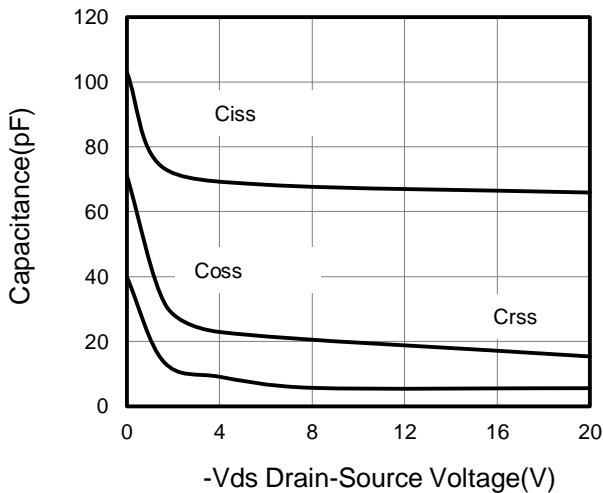
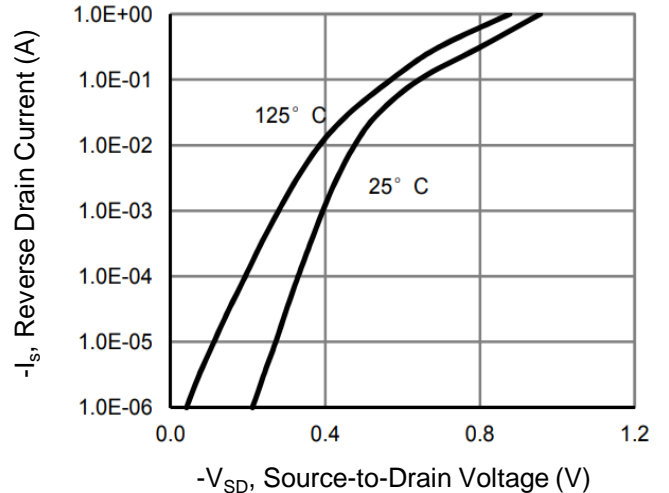


Figure 6. Source-Drain Diode Forward



PMOS Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

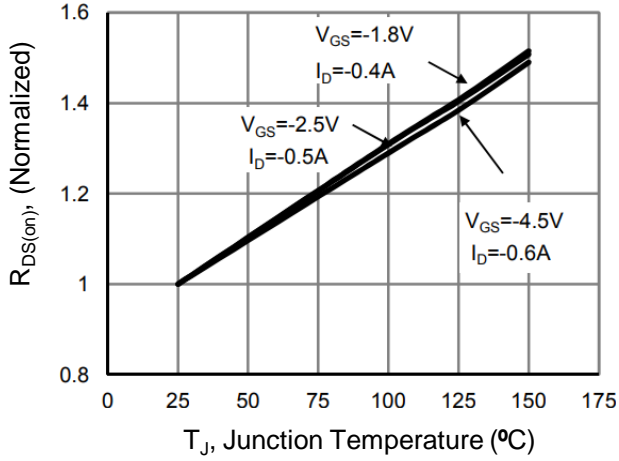


Figure 8. Safe Operation Area

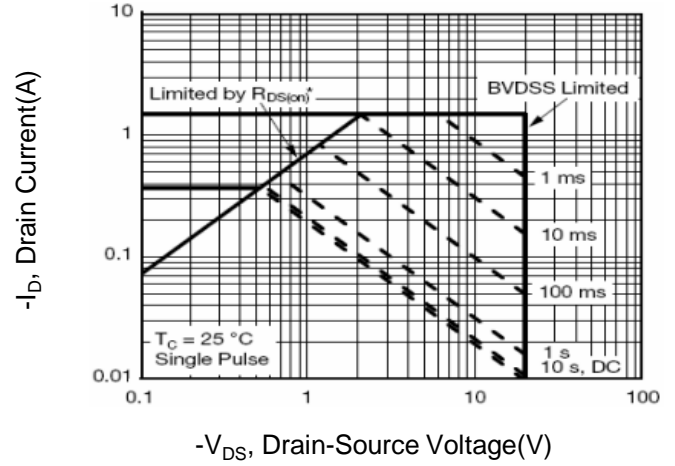
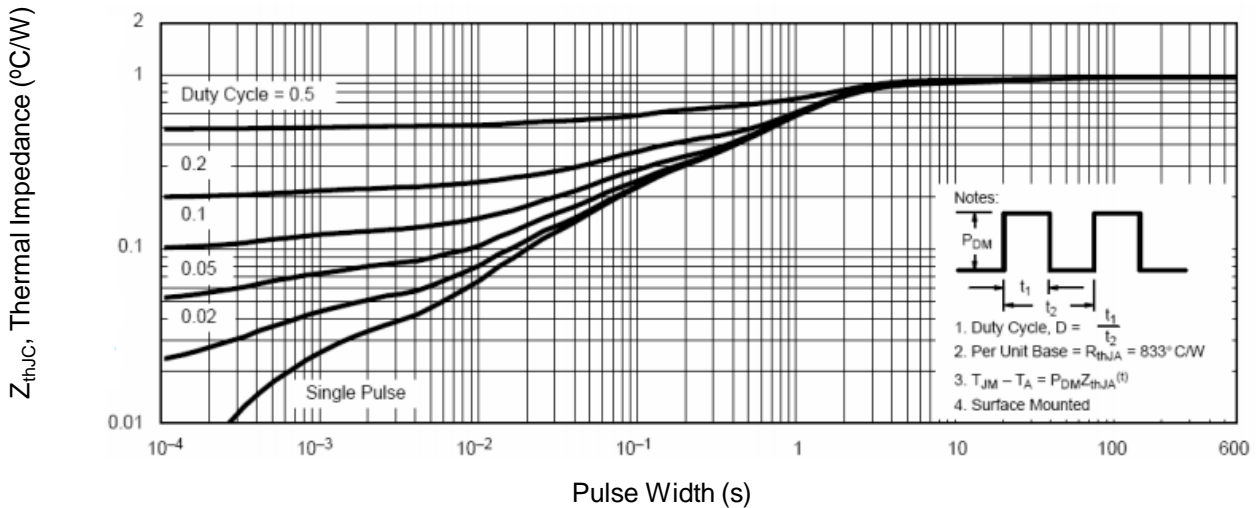
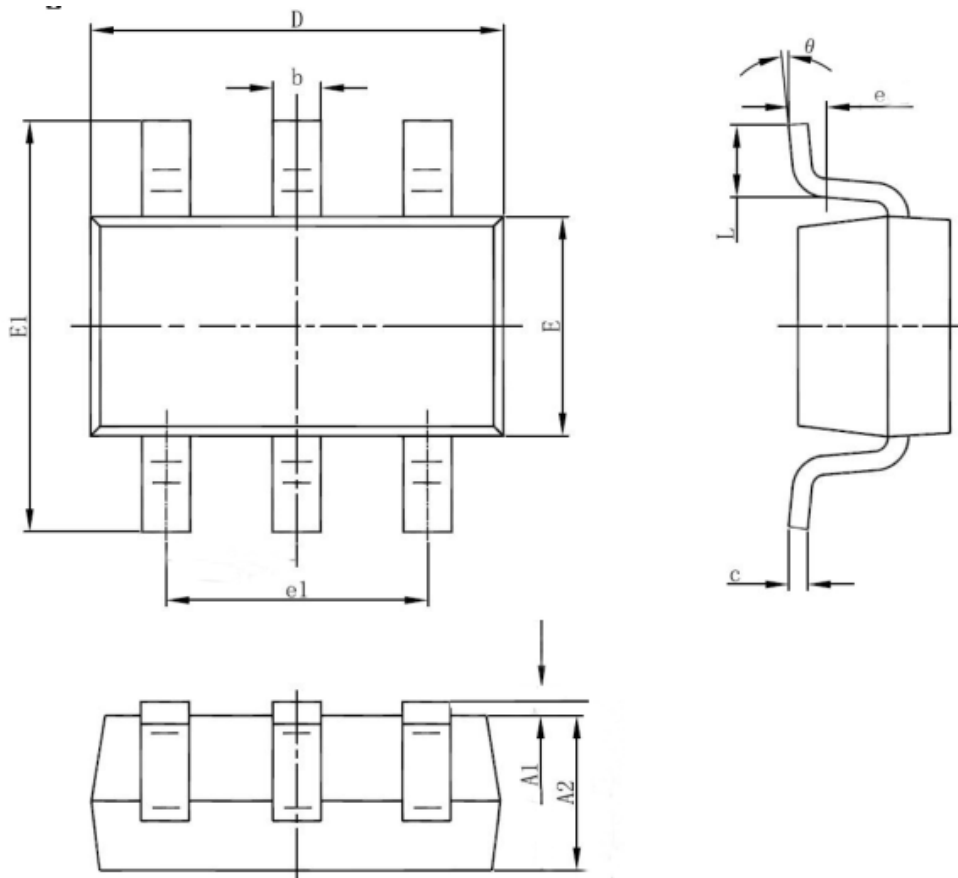


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23-6L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	NOM.	MAX.
A1	0.00	-	0.10
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.10	0.15	0.20
D	2.80	2.90	3.00
E	1.50	1.60	1.70
E1	2.60	2.80	3.00
e	0.2GAUGE PLANE		
e1	-	1.90	-
L	0.30	0.45	0.60
θ	0°	-	8°
All Dimensions in mm			